506971450 11/10/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7018288

SUBMISSION TYPE:	CORRECTIVE ASSIGNMENT
NATURE OF CONVEYANCE:	Corrective Assignment to correct the ASSIGNEES previously recorded on Reel 052323 Frame 0430. Assignor(s) hereby confirms the ASSIGNEES ARE TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD. AND TSMC NANJING COMPANY, LIMITED.

CONVEYING PARTY DATA

Name	Execution Date
MIN HAN HSU	03/25/2020
CHUN-CHANG CHEN	03/25/2020
JUNG-CHIH TSAO	03/25/2020

RECEIVING PARTY DATA

TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
8, LI-HSING RD. 6, HSINCHU SCIENCE PARK
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TAIWAN
300-78
TSMC NANJING COMPANY, LIMITED
16, ZIFENG ROAD, PUKOU ECONOMIC DEVELOPMENT ZONE, JIANGSU PROVINCE
1.1.6 1.1.6 1
NANJING

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16801706

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	T5057-1408
NAME OF SUBMITTER:	RANDY A. NORANBROCK

PATENT 506971450 REEL: 058099 FRAME: 0610

SIGNATURE:	/Randy A. Noranbrock/
DATE SIGNED:	11/10/2021
Total Attachments: 5	
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PATENT REEL: 058099 FRAME: 0611



Docket No. T5057-1408 P20182130US00

NP-25814-0-US-B3

ASSIGNMENT

In consideration of the premises and or	her good and valuable cor	nsideration in hand paid, th	he receipt and sufficiency of
which is hereby acknowledged, the undersigned,		•	

Min Han HSU .

3) Jung-Chih TSAO

Chun-Chang CHEN

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hsin Rd. VI. Hsinchu Science Park Hsinchu 300, Taiwan R.O.C. and TSMC NANJING COMPANY, LIMITED, having a clace of business at 16, Zifeng Road Pukou Economic Development Zone, Nanjing, Jiangsu Province, China its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

NE

POISONED METAL LAYER WITH SLOPE	D SIDEWALL FOR MAKING DUAL DAMASCENE
INTERCONNECT	
(a) for which an application for United States Letters P United States Patent Application No	ratent was filed on 2020-02-26 , and identified by 26 ; or
(b) for which an application for United States Letters P	atent was executed on
all United States Letters Patent which may be granted there continuations-in-part thereof, and the right to all benefits Property to the said ASSIGNEE, for its interest as ASSIGN agrees that the attorneys of record in said application shall be AND the undersigned hereby agrees to transfer application for and obtaining original, divisional, reissued or ASSIGNEE, its successors, assigns and legal representative applications for patent based thereon, growing out of or r	ited States Commissioner of Patents and Trademarks to issue any and affore and any and all extensions, divisions, reissues, continuations, or under the International Convention for the Protection of Industrial IEE, its successors, assigns and legal representatives; the undersigned creatier act on behalf of said ASSIGNEE; a like interest, and to render all necessary assistance in making restended Letters Patent of the United States, upon request of the said is, and without further renuncration, in and to any improvements, and related to the said invention; and to execute any papers by the said is, deemed essential to ASSIGNEE's full protection and title in and to
SIGNED on the date indicated aside my signature:	
1) Min Han HSU Name: Min Han HSU	Date:
2) Chun - Chang Chen Name: Chun-Chang CHEN	2020.3.7S
	Date:
3) Juy - Wh São Name: Jung-Chih TSAO	>070. 3. y
Name: Jung-Chia TSAO	Date:



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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MIN HAN HSU	03/25/2020
CHUN-CHANG CHEN	03/25/2020
JUNG-CHIH TSAO	03/25/2020

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
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State/Country:	TAIWAN
Postal Code:	300

TSMC NA	IJING COMPANY,
LIMITED	

	COad, POKOU
• •	Development Zone

Nanjing Jiangsu Province CHINA

PROPERTY NUMBERS Total: 1

Property Type	Number	Contractor Contractor
Application Number:	16801706	-

CORRESPONDENCE DATA

PATENT

REEL: 058099 FRAME: 064/3/2020, 5:37 PM

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number, if provided; if that is unsuccessful, it will be sent via US Mail.

Correspondent Name: HAUPTMAN HAM, LLP (TSMC)

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Address Line 4: ALEXANDRIA, VIRGINIA 22314

ATTORNEY DOCKET NUMBER:

T5057-1408

NAME OF SUBMITTER:

RANDY A. NORANBROCK

Signature:

/Randy A. Noranbrock/

Date:

04/06/2020

Total Attachments: 1

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RECEIPT INFORMATION

EPAS ID: PAT6048653 **Receipt Date:** 04/06/2020

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APRIL 7, 2020

PTAS

HAUPTMAN HAM, LLP (TSMC) 2318 MILL ROAD SUITE 1400 ALEXANDRIA, VA 22314 506001943

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RECORDATION DATE: 04/06/2020 REEL/FRAME: 052323/0430

NUMBER OF PAGES: 2

BRIEF: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

DOCKET NUMBER: T5057-1408

ASSIGNOR:

HSU, MIN HAN DOC DATE: 03/25/2020

ASSIGNOR:

CHEN, CHUN-CHANG DOC DATE: 03/25/2020

ASSIGNOR:

TSAO, JUNG-CHIH DOC DATE: 03/25/2020

ASSIGNEE:

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Nanjing, Jiangsu Province, CHINA

TSMC NANJING COMPANY, LIMITED

APPLICATION NUMBER: 16801706 FILING DATE: 02/26/2020

PATENT NUMBER: ISSUE DATE:

TITLE: POISONED METAL LAYER WITH SLOPED SIDEWALL FOR MAKING DUAL

DAMASCENE INTERCONNECT

 ASSIGNMENT RECORDATION BRANCH PUBLIC RECORDS DIVISION

RECORDED: 11/10/2021

PATENT REEL: 058099 FRAME: 0616